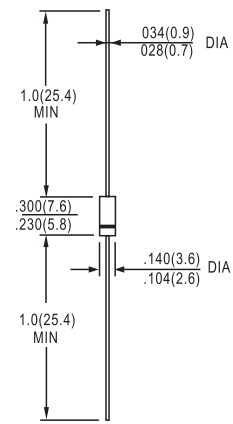


FEATURES

- Diffused Junction
- Ultra-Fast Switching for High Efficiency
- High Current Capability and Low Forward Voltage Drop
- Surge Overload Rating to 60A Peak
- Low Reverse Leakage Current
- **Lead Free Finish, RoHS Compliant (Note 4)**

Mechanical Data

- Case: Molded Plastic
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish – Bright Tin. Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking: Type Number
- Mounting Position: Any
- Weight: 0.4 grams (approximate)



DO-15

Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	UF 2001	UF 2002	UF 2003	UF 2004	UF 2005	UF 2006	UF 2007	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V_{RWM}								
DC Blocking Voltage	V_R								
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1)	I_O	2.0							A
		@ $T_A = 50^\circ\text{C}$							
Non-Repetitive Peak Forward Surge Current	I_{FSM}	60							A
		8.3ms Single half sine-wave Superimposed on Rated Load (JEDEC Method)							
Forward Voltage	V_{FM}		1.0		1.3		1.7		V
		@ $I_F = 2.0\text{A}$							
Peak Reverse Current	I_{RM}	5.0							μA
		@ $T_A = 25^\circ\text{C}$							
		@ $T_A = 100^\circ\text{C}$		100					
Reverse Recovery Time (Note 3)	t_{rr}	50				75			ns
Typical Junction Capacitance (Note 2)	C_j	50				30			pF
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	50							K/W
Operating and Storage Temperature Range	T_j, T_{STG}	-65 to +150							$^\circ\text{C}$

- Notes:
1. Valid provided that leads are maintained at ambient temperature at a distance of 9.5mm from the case.
 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
 3. Measured at $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $I_{rr} = 0.25\text{A}$. See figure 5.
 4. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see *EU Directive Annex Notes 5 and 7*.

RATINGS AND CHARACTERISTIC CURVES UF2001 THRU UF2007

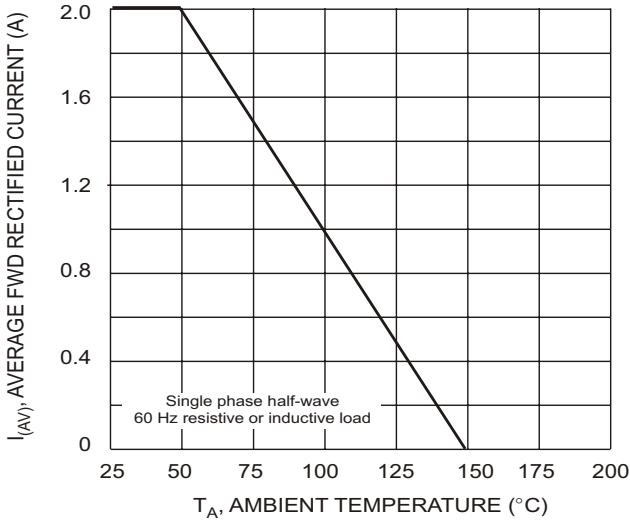


Fig. 1 Forward Current Derating Curve

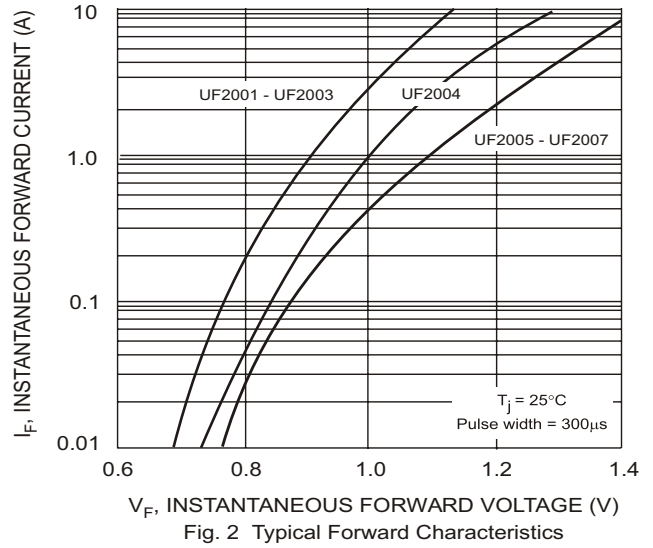


Fig. 2 Typical Forward Characteristics

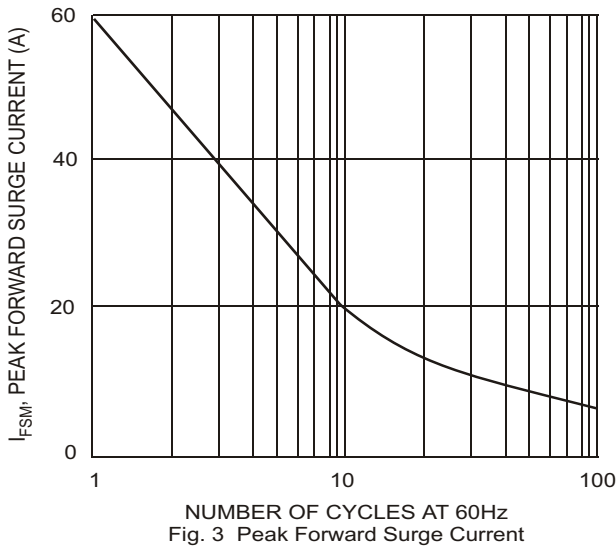


Fig. 3 Peak Forward Surge Current

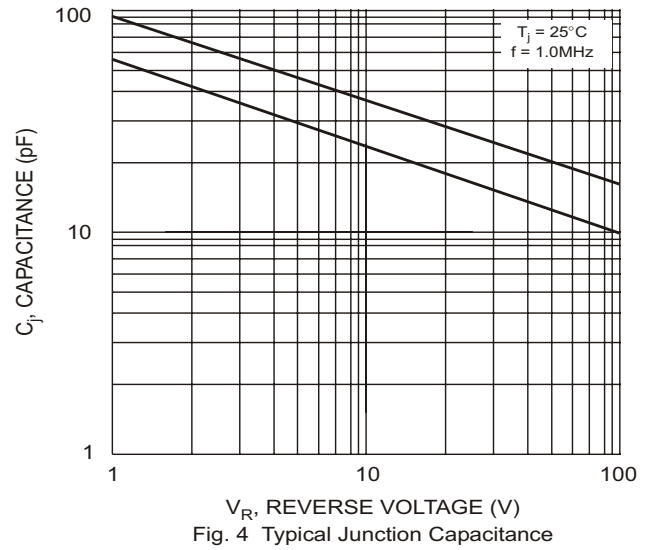
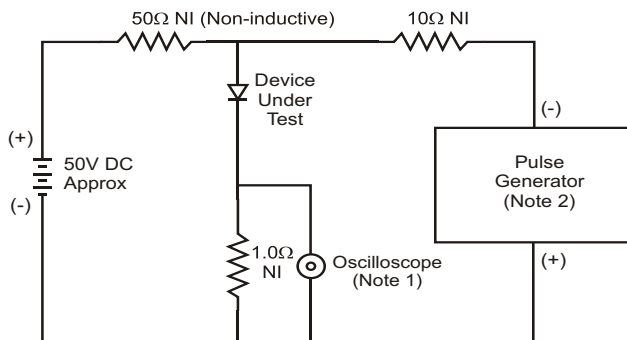
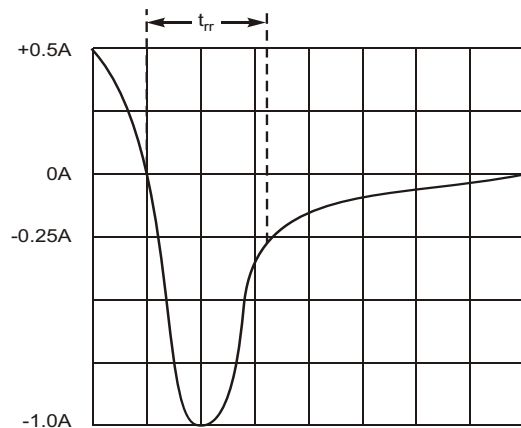


Fig. 4 Typical Junction Capacitance



- Notes:
 1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
 2. Rise Time = 10ns max. Input Impedance = 50Ω.



Set time base for 50/100 ns/cm

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit